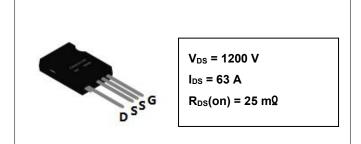


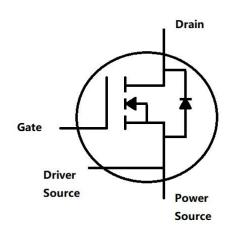
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S2M0025120K 1200V SIC POWER MOSFET



Circuit Diagram



Description

S2M0025120K is single SiC Power MOSFET packaged in TO-247-4 case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0025120K is ideal for energy sensitive, high frequency applications in challenging environments.

Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 25mΩ .
- Fast switching speed and low switching losses.
- Very fast and robust intrinsic body diode.
- Process of non-bright Tin electroplatin

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

Characteristics Symbol Condition Max. Units 1200 V Drain Source Voltage VDSS V_{GS} = 0V, I_{DS} = 100uA, T_j = 25°C Gate Source Voltage V_{GSS} $T_i = 25^{\circ}C$, Absolute maximum values, AC (f>1Hz) -10 to +25 V -5 to +20 V Gate Source Voltage V_{GSOP} T_i = 25°C Recommended Operational Values **Continuous Drain Current** I_D $V_{GS} = 20V, T_i = 25^{\circ}C$ 63 А $V_{GS} = 20V, T_i = 100^{\circ}C$ 40 А ΙD Pulsed Drain Current I_{D,pulse} Pulse width t_P limited by T_{jmax} 250 А Power Dissipation \mathbf{P}_{D} Tc=25°C, TJ = 150 °C 446 W TL 260 Solder Temperature 1.6mm (0.063") from case for 10s °C

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Maximum Ratings(T=25°C unless otherwise specified)



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Electrical Characteristics(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition Min.		Тур.	Max.	Units	
Drain Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 100uA	0V, I _D = 100uA 1200			V	
	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 15 \text{mA}$	1.8	2.1	4	V	
Gate Threshold Voltage		V _{DS} = V _{GS} , I _D = 15mA, T _J = 150 °C		1.4		V	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 1200V, V _{GS} = 0V	_{PS} = 1200V, V _{GS} = 0V 2 100		100	uA	
Gate Source Leakage Current	I _{GSS}	V _{GS} = 20V, V _{DS} = 0V			250	nA	
Drain Source On-State	-	V _{GS} = 20V, I _D = 50A		25	34	mΩ	
Resistance	$R_{DS(on)}$	V _{GS} = 20V, I _D = 50A, T _J = 150 °C		41		mΩ	
	ç	V _{DS} = 20 V, I _{DS} = 50 A		13		S	
Transconductance	gfs	V _{DS} = 20 V, I _{DS} = 50 A, T _J = 150 °C		14		S	
Input Capacitance	CISS	V _{GS} = 0V,		4402			
Output Capacitance	Coss	V _{DS} = 1000V		257		pF	
Reverse Transfer Capacitance	C _{RSS}	V _{AC} = 25mV 7					
Coss Stored Energy	Eoss	f = 1MHz	128		uJ		
Turn-On Switching Energy	Eon	V _{DS} = 800V, V _{GS} = -5/20V	0.61				
Turn-Off Switching Energy	EOFF	$I_{D} = 50A, R_{G(ext)} = 2.5\Omega$		0.31		mJ	
Turn-On Delay Time	t _{d(on)}	V _{DS} = 800V, V _{GS} = -5/20V 20					
Rise Time	tr	$I_{D} = 50A, R_{G(ext)} = 2.5\Omega$		24			
Turn-Off Delay Time	$t_{d(off)}$			36		ns	
Fall Time	t _f			18			
Internal Gate Resistance	$R_{G(int)}$	f = 1MHz, VAC = 25 mV 2.5		Ω			
Gate to Source Charge	Q_{gs}	V _{DS} = 800V, V _{GS} = -5/20V 37					
Gate to Drain Charge	Q_gd	I _D = 50A		38		nC	
Total Gate Charge	Qg			130			



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Reverse Diode Characteristics:

Characteristics	Symbol	mbol Condition		Max.	Units
Diode Forward Voltage	Vsd	V _{GS} = -5V, I _{SD} = 25A			V
		V _{GS} = -5V, I _{SD} = 25A, T _J = 150°C	3.6		V
Continuous Diode Forward Current	ls	V _{GS} = -5V, T _C = 25℃		63	А
Reverse Recovery Time	t _{rr}	V _{GS} = -5V, I _{SD} = 50A, T _J = 25°C	48		ns
Reverse Recovery Charge	Q _{rr}	V _R = 800V	354		nC
Peak Reverse Recovery Current	I _{mm}	dif/dt= 1057A/µs	12		А

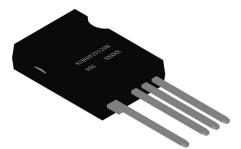
Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	Rejc	DC operation	0.28	°C/W
Typical Thermal Resistance Junction to Ambient	R _{0JA}		32	°C/W

Ordering Information:

Device	Package	Shipping
S2M0025120K	TO-247-4	30pcs/tube

Marking Diagram



Where XXXXX is YYWWL

- S2M = Device Type 0025
- = R_{DS}(on) 120 = Reverse Voltage (1200V)
- = Package Κ
- SSG = SSG YY

1

- = Year WW = Week
 - = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

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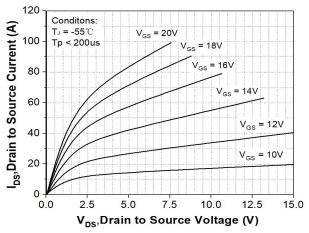
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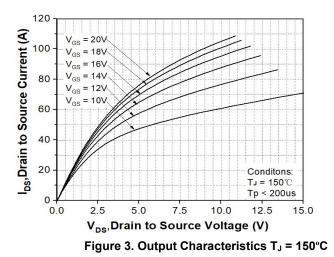
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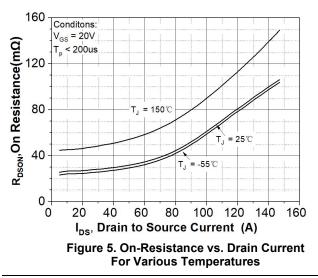
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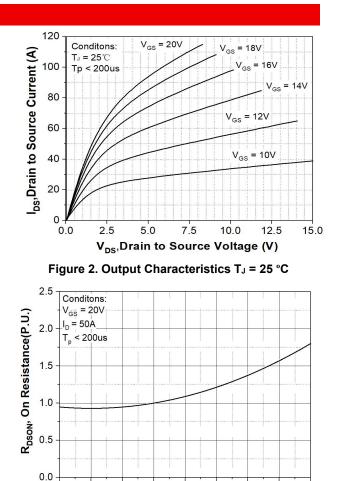
Ratings and Characteristics Curves











25 T_., Junction Temperature (℃) Figure 4. Normalized On-Resistance vs. Temperature

50

75

100

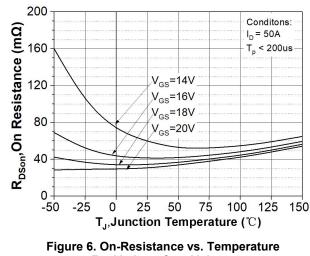
125

150

-25

0

-50



For Various Gate Voltage

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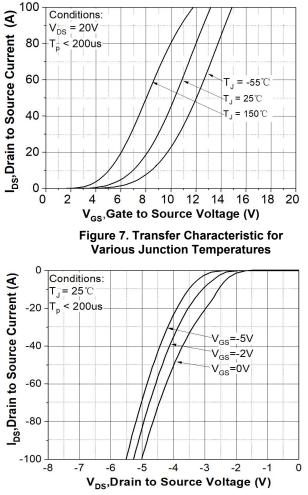


Figure 9. Body Diode Characteristic at T_J = 25 °C

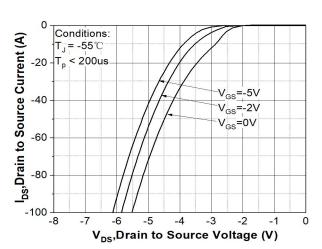


Figure 8. Body Diode Characteristic at T_J = -55 °C

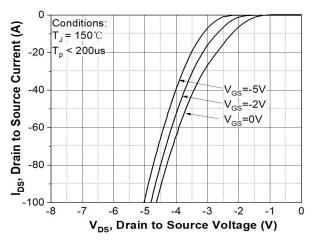
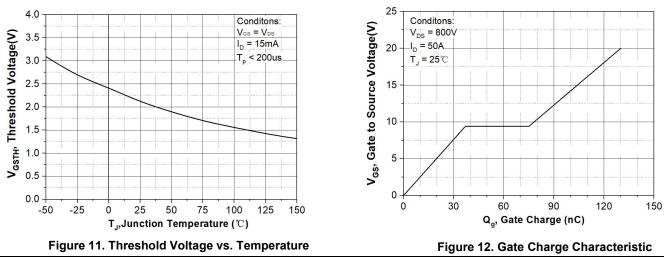


Figure 10. Body Diode Characteristic at T_J = 150 °C

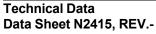


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SOLUTIONS

S2M0025120K



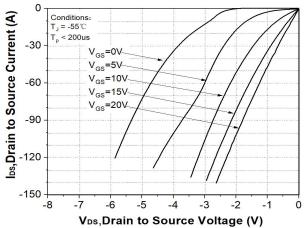


Figure 13. 3rd Quadrant Characteristic at T_J = -55 °C

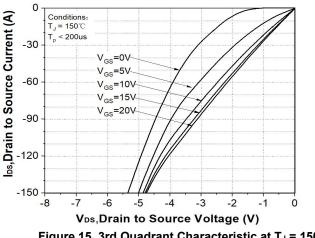
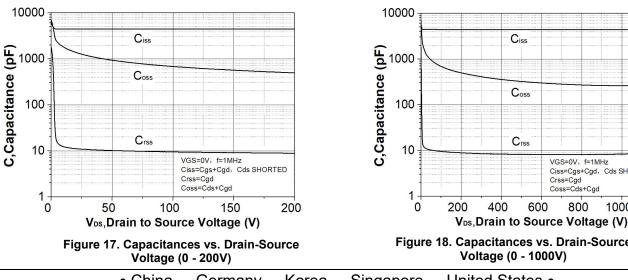


Figure 15. 3rd Quadrant Characteristic at T_J = 150°C



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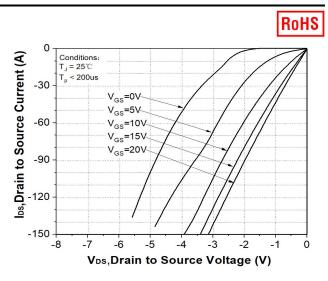


Figure 14. 3rd Quadrant Characteristic at T_J = 25 °C

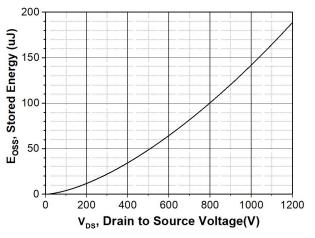
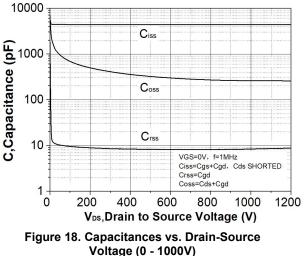


Figure 16. Output Capacitor Stored Energy



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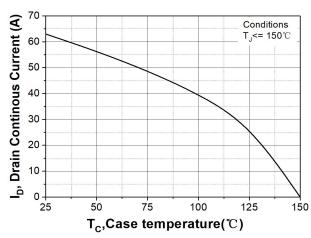


Figure 19. Continuous Drain Current Derating vs. Case Temperature

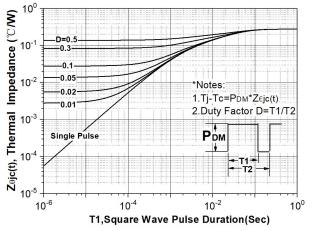


Figure 21. Transient Thermal Impedance (Junction - Case)

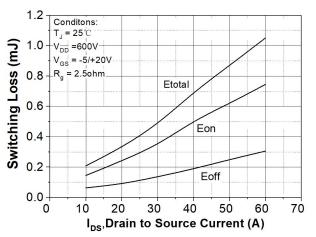


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)

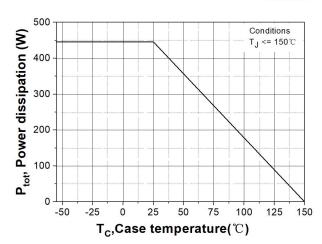


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

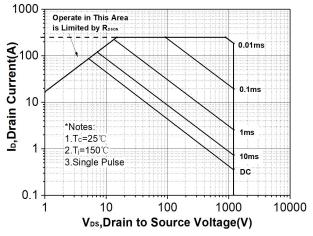


Figure 22. Safe Operating Area

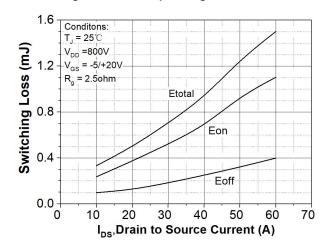


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

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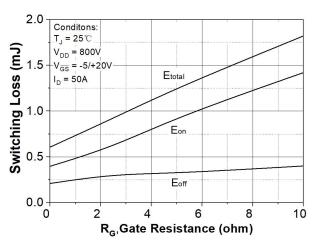


Figure 25. Clamped Inductive Switching Energy vs. RG(ext)

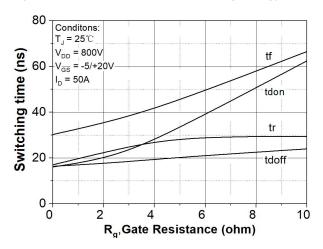
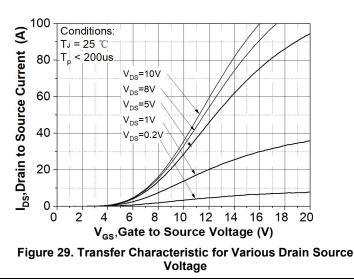


Figure 27. Switching Times vs. R_{G(ext)}



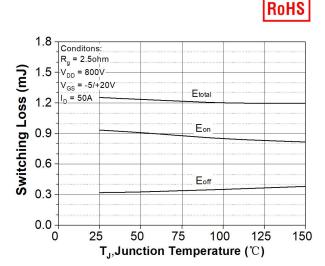


Figure 26. Clamped Inductive Switching Energy vs. Temperature

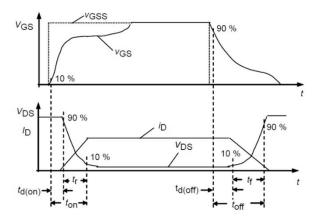


Figure 28. Switching Times Definition

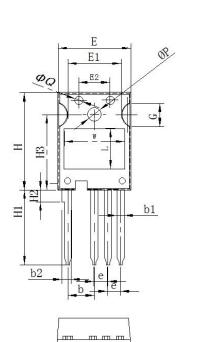
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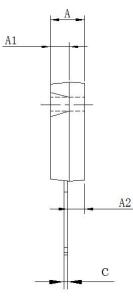
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Mechanical Dimensions TO-247-4



1

2 3 4



Symbol	In mm			
Symbol	Min	Nom	Max	
А	4.80	5.00	5.21	
A1	2.29	3.00	3.20	
A2	1.91	2.40	2.60	
b	4.85	5.05	5.25	
b1	1.05	1.25	1.60	
b2	1.07	2.30	2.50	
С	0.50	0.60	0.70	
е	2.35	2.55	2.75	
E	15.50	15.70	16.13	
E1	10.50	10.70	10.90	
E2	6.35	7.60	7.80	
G	4.80	5.00	5.20	
Н	22.40	22.60	23.60	
H1	17.31	18.50	18.70	
H2	2.50	3.00	4.37	
H3	16.00	16.50	17.00	
ΦP	3.00	3.60	3.80	
ΦQ	2.20	2.50	3.00	

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